

## Silicon Controlled Rectifiers Reverse Blocking Triode Thyristor

... designed for industrial and consumer applications such as power supplies, battery chargers, temperature, motor, light and welder controls.

- Supplied in Either Pressfit or Stud Package
- High Surge Current Rating —  $I_{TSM} = 240$  Amps
- Low On-State Voltage — 1.2 V (Typ) @  $I_{TM} = 20$  Amps
- Practical Level Triggering and Holding Characteristics — 40 mA (Max) and 50 mA (Max) @  $T_C = 25^\circ\text{C}$

**2N5164  
thru  
2N5171**

**SCRs  
20 AMPERES RMS  
50 thru 600 VOLTS**



### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
*Peak Forward and *Repetitive Reverse Blocking Voltage, Notes 1 and 2 2N5164, 2N5168 2N5165, 2N5169 2N5166, 2N5170 2N5167, 2N5171	$V_{DRM}$ or $V_{RRM}$	50 200 400 600	Volts
*Non-Repetitive Peak Reverse Blocking Voltage 2N5164, 2N5168 2N5165, 2N5169 2N5166, 2N5170 2N5167, 2N5171	$V_{RSM}$	75 300 500 700	Volts
On-State Current RMS	$I_T(\text{RMS})$	20	Amps
Average On-State Current ( $T_C = 67^\circ\text{C}$ )	$I_T(\text{AV})$	13	Amps
Circuit Fusing ( $T_J = -40$ to $+100^\circ\text{C}$ , $t \leq 8.3$ ms)	$I^2t$	235	$\text{A}^2\text{s}$
*Peak Non-Repetitive Surge Current (One cycle, 60 Hz, $T_J = -40$ to $+100^\circ\text{C}$ ) Preceded and followed by rated current and voltage	$I_{TSM}$	240	Amps
*Peak Gate Power (Maximum Pulse Width = 10 $\mu\text{s}$ )	$P_{GM}$	5	Watts
*Average Gate Power	$P_{G(\text{AV})}$	0.5	Watt
*Peak Forward Gate Current (Maximum Pulse Width = 10 $\mu\text{s}$ )	$I_{GM}$	2	Amps
Peak Gate Voltage	$V_{GM}$	10	Volts
*Operating Junction Temperature Range	$T_J$	-40 to +100	$^\circ\text{C}$
*Storage Temperature Range	$T_{\text{stg}}$	-40 to +150	$^\circ\text{C}$
Stud Torque 2N5168-2N5171		30	in. lb.

\*Indicates JEDEC registered data.

Notes: 1.  $V_{DRM}$  for all types can be applied on a continuous dc basis without incurring damage. Ratings apply for zero or negative gate voltage. Devices should not be tested for blocking capability in a manner such that the voltage applied exceeds the rated blocking voltage.

2. Devices should not be operated with a positive bias applied to the gate concurrent with a negative potential applied to the anode.



**CASE 263-04  
STYLE 1  
2N5168 thru 2N5171**



**CASE 310-02  
STYLE 1  
2N5164 thru 2N5167**

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2N5164 thru 2N5171

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Typ	Max	Unit
*Thermal Resistance, Junction to Case 2N5164, 65, 66, 67 2N5168, 69, 70, 71	$R_{\theta JC}$	1 1.1	1.5 1.6	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
*Peak Forward or Reverse Blocking Current (Rated $V_{DRM}$ or $V_{RRM}$ , gate open) $T_J = 25^\circ\text{C}$ $T_J = 100^\circ\text{C}$	$I_{DRM}, I_{RRM}$	— —	10 5	$\mu\text{A}$ mA
Gate Trigger Current (Continuous dc), Note 1 ( $V_D = 7 \text{ Vdc}$ , $R_L = 100 \Omega$ ) *( $V_D = 7 \text{ Vdc}$ , $R_L = 100 \Omega$ , $T_C = -40^\circ\text{C}$ )	$I_{GT}$	— —	40 75	mA
Gate Trigger Voltage (Continuous dc) ( $V_D = 7 \text{ Vdc}$ , gate open) *( $V_D = 7 \text{ Vdc}$ , $R_L = 100 \Omega$ , $T_C = -40^\circ\text{C}$ ) *( $V_D = \text{Rated } V_{DRM}$ , $R_L = 100 \Omega$ , $T_J = 100^\circ\text{C}$ )	$V_{GT}$	— — 0.2	1.5 2.5 —	Volts
Peak On-State Voltage (Pulse Width = 1 ms max, duty cycle $\leq 1\%$ ) ( $I_{TM} = 20 \text{ A}$ ) *( $I_{TM} = 41 \text{ A}$ )	$V_{TM}$	— 8	1.5 1.7	Volts
Holding Current ( $V_D = 7 \text{ Vdc}$ , gate open) *( $V_D = 7 \text{ Vdc}$ , gate open, $T_C = -40^\circ\text{C}$ )	$I_H$	— —	50 90	mA
Gate Controlled Turn-On Time ( $t_d + t_r$ ) ( $I_{TM} = 20 \text{ A}$ , $I_{GT} = 40 \text{ mAdc}$ , $V_D = \text{Rated } V_{DRM}$ )	$t_{gt}$	Typical		$\mu\text{s}$
		1		
Circuit Commutated Turn-Off Time ( $I_{TM} = 10 \text{ A}$ , $I_R = 10 \text{ A}$ ) ( $I_{TM} = 10 \text{ A}$ , $I_R = 10 \text{ A}$ , $T_J = 100^\circ\text{C}$ ) ( $V_D = V_{DRM} = \text{rated voltage}$ ) ( $dv/dt = 30 \text{ V}/\mu\text{s}$ )	$t_q$	20 30		$\mu\text{s}$
Critical Rate of Rise of Off-State Voltage ( $V_D = \text{Rated } V_{DRM}$ , Exponential Wave Form, Gate open, $T_J = 100^\circ\text{C}$ )	$dv/dt$	50		$\text{V}/\mu\text{s}$

\*Indicates JEDEC registered data.

Note 1. Devices should not be operated with a positive bias applied to the gate concurrent with a negative potential applied to the anode.

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EFFECT OF TEMPERATURE UPON TYPICAL TRIGGER CHARACTERISTICS

FIGURE 1 - GATE TRIGGER CURRENT

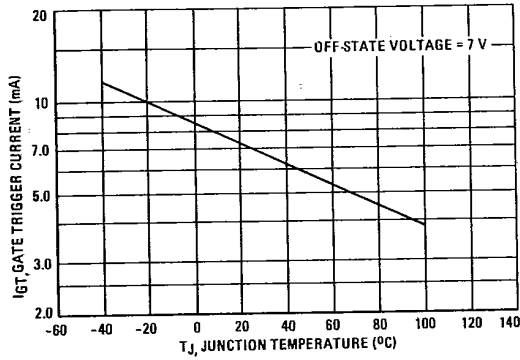
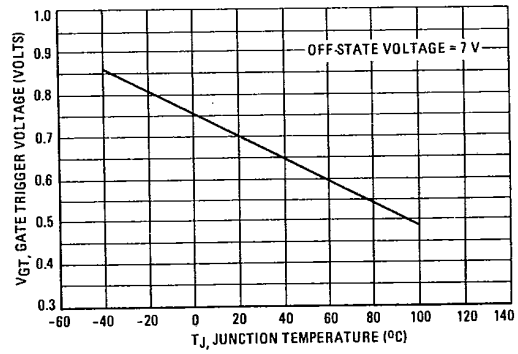


FIGURE 2 - GATE TRIGGER VOLTAGE



MAXIMUM ALLOWABLE NON-REPETITIVE SURGE CURRENT

FIGURE 3 - 60 Hz SURGES

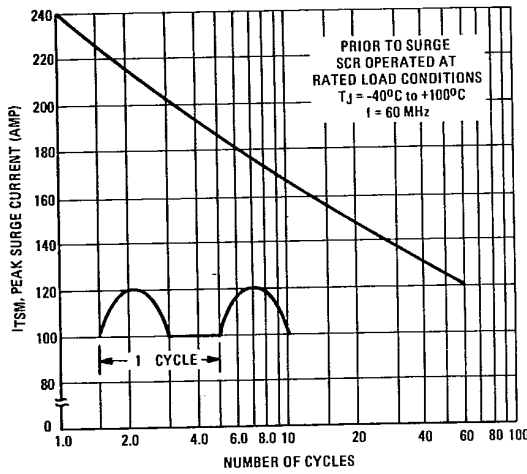
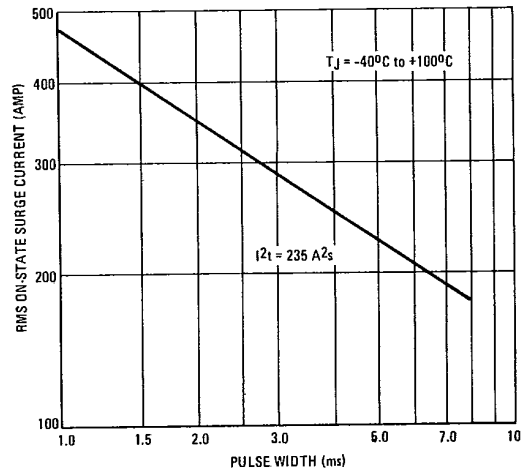


FIGURE 4 - SUB-CYCLE SURGES



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2N5164 thru 2N5171

FIGURE 5 - GATE TRIGGER CHARACTERISTICS

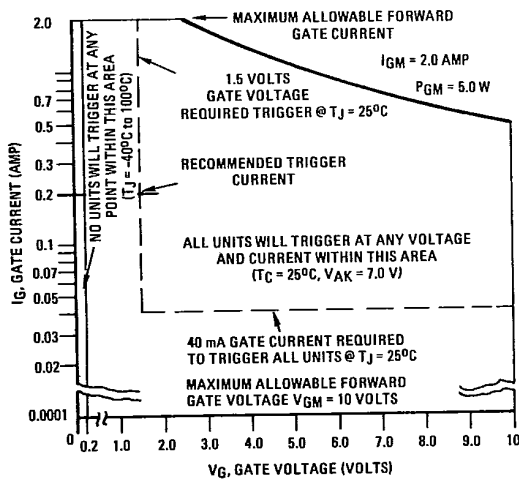
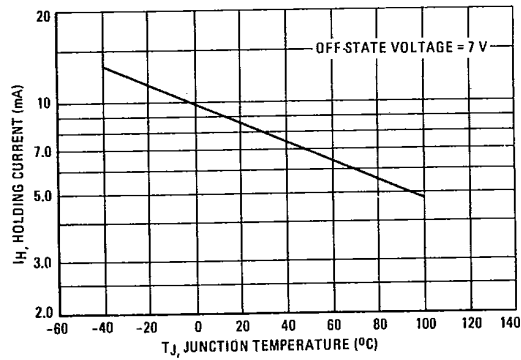


FIGURE 6 - EFFECT OF TEMPERATURE ON TYPICAL HOLDING CURRENT



DERATING AND DISSIPATION FOR RESISTIVE AND INDUCTIVE LOADS (f = 60 to 400 Hz, SINE WAVE)

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FIGURE 7 - AVERAGE CURRENT DERATING

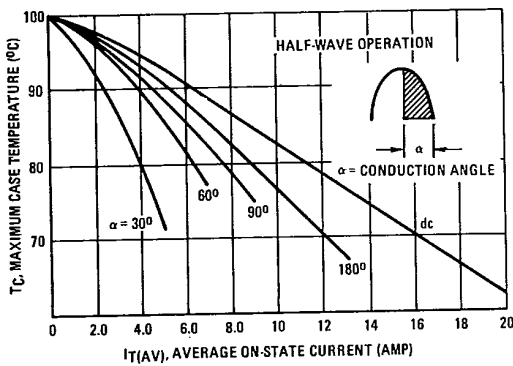


FIGURE 8 - ON-STATE POWER DISSIPATION

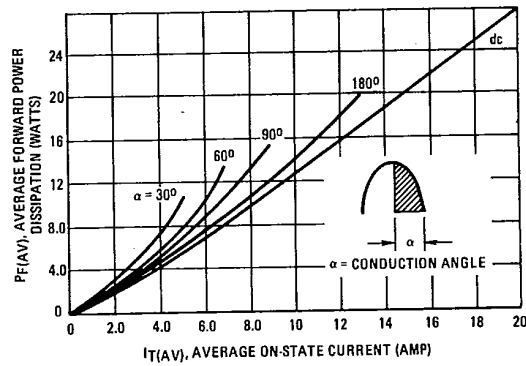


FIGURE 9 - ON-STATE CHARACTERISTICS

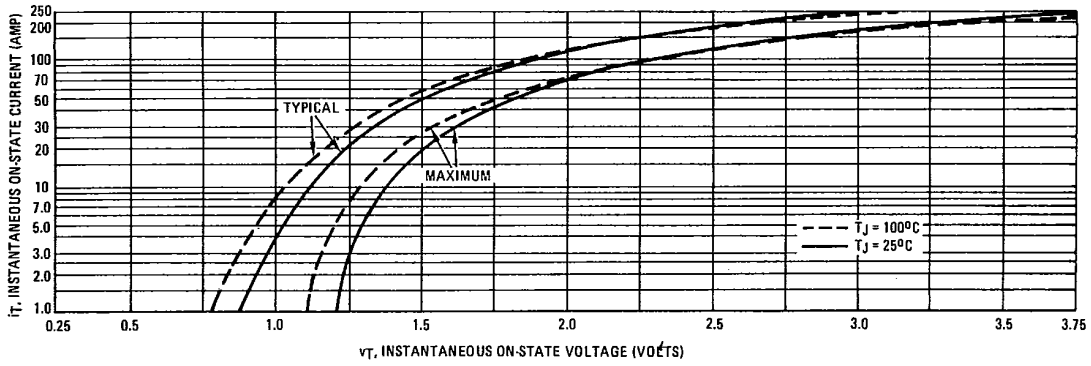


FIGURE 10 - TYPICAL THERMAL RESISTANCE OF PLATES

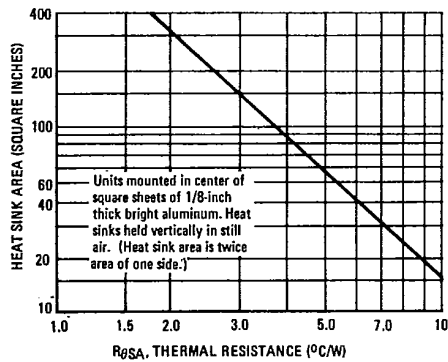
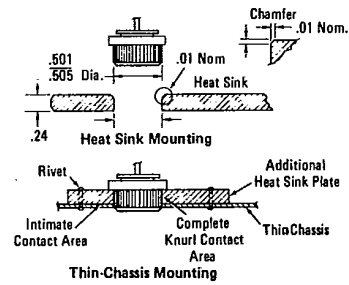


FIGURE 11 - MOUNTING DETAILS FOR PRESSFIT THYRISTORS



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